Power MOSFET 30 V, 171 A, Single N-Channel, SO-8 FL

Features

- Low R_{DS(on)} to Minimize Conduction Losses
- Low Capacitance to Minimize Driver Losses
- Includes Schottky Diode
- Optimized Gate Charge to Minimize Switching Losses
- Dual Sided Cooling Capability
- These are Pb-Free Device

Applications

- CPU Power Delivery
- DC-DC Converters
- Low Side Switching

MAXIMUM RATINGS (T_J = $25^{\circ}C$ unless otherwise stated)

Para	ameter		Symbol	Value	Unit
Drain-to-Source Vo	Itage		V _{DSS}	30	V
Gate-to-Source Vol	tage		V _{GS}	±20	V
Continuous Drain		T _A = 25°C	Ι _D	29	А
Current R _{θJA} (Note 1)		T _A = 85°C		21	
Power Dissipation $R_{\theta JA}$ (Note 1)		T _A = 25°C	P _D	2.74	W
Continuous Drain		T _A = 25°C	Ι _D	47	А
Current $R_{\theta JA} \leq$ 10 sec		T _A = 85°C		34	
Power Dissipation $R_{\theta JA,} t \leq 10 \text{ sec}$	Steady	T _A = 25°C	P _D	7.3	W
Continuous Drain Current R _{θJA}	State	T _A = 25°C	I _D	17	А
(Note 2)		T _A = 85°C		12	
Power Dissipation $R_{\theta JA}$ (Note 2)		T _A = 25°C	PD	0.95	W
Continuous Drain		T _C = 25°C	Ι _D	171	А
Current R _{θJC} (Note 1)		T _C = 85°C		123	
Power Dissipation $R_{\theta JC}$ (Note 1)		T _C = 25°C	PD	96.2	W
Pulsed Drain Current	t _p =10μs	T _A = 25°C	I _{DM}	288	A
Current limited by pa	ickage	T _A = 25°C	I _{Dmaxpkg}	100	А
Operating Junction a Temperature	nd Storage	•	T _J , T _{STG}	–40 to +150	°C
Source Current (Boo	ly Diode)		۱ _S	120	А
Drain to Source dV/c	Drain to Source dV/dt			6	V/ns
$ \begin{array}{l} \mbox{Single Pulse Drain-to-Source Avalanche} \\ \mbox{Energy (V}_{DD} = 50 \mbox{ V, V}_{GS} = 10 \mbox{ V,} \\ \mbox{I}_L = 50 \mbox{ A}_{pk}, \mbox{ L} = 0.3 \mbox{ mH, R}_G = 25 \Omega) \end{array} $			EAS	375	mJ
Lead Temperature for (1/8" from case for 1		Purposes	ΤL	260	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

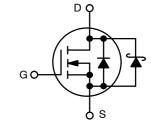


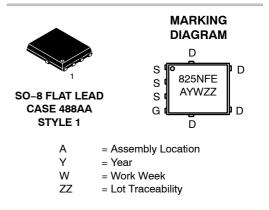
ON Semiconductor®

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V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX
30 V	2.0 mΩ @ 10 V	171 A
50 V	3.0 mΩ @ 4.5 V	140 A







ORDERING INFORMATION

Device	Package	Shipping [†]
NTMFS4825NFET1G	SO-8FL (Pb-Free)	1500 / Tape & Reel
NTMFS4825NFET3G	SO-8FL (Pb-Free)	5000 / Tape & Reel

+ For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Case (Drain)	$R_{\theta JC}$	1.3	
Junction-to-Ambient - Steady State (Note 1)	$R_{\theta JA}$	45.7	1
Junction-to-Ambient - Steady State (Note 2)	$R_{\theta JA}$	132.1	°C/W
Junction-to-Ambient – t \leq 10 sec	$R_{ hetaJA}$	17.2	1
Junction-to-Top	$R_{\theta JT}$	7.0	

1. Surface-mounted on FR4 board using 1 sq-in pad, 1 oz Cu.

2. Surface-mounted on FR4 board using the minimum recommended pad size.

ELECTRICAL CHARACTERISTICS (T_J = $25^{\circ}C$ unless otherwise specified)

Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS							
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0 V, I _D = 1.0 mA		30			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} / T _J				28.5		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V, V _{DS} = 24 V	T _J = 25 °C		60	500	μΑ
Gate-to-Source Leakage Current	I _{GSS}	V_{DS} = 0 V, V_{GS}	= ±20 V			±100	nA

ON CHARACTERISTICS (Note 3)

Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}$, $I_D = 1.0 \text{ mA}$		1.5	2.0	2.5	V
Negative Threshold Temperature Coefficient	V _{GS(TH)} /T _J		_		4		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 22 A		1.3	2.0	
			I _D = 20 A		1.3		
		V _{GS} = 4.5 V	I _D = 20 A		2.0	3.0	mΩ
			I _D = 18 A		2.0		
Forward Transconductance	9 _{FS}	V _{DS} = 15 V, I _D = 15 A			90		S

CHARGES AND CAPACITANCES

Input Capacitance	C _{ISS}		5660	
Output Capacitance	C _{OSS}	V_{GS} = 0 V, f = 1 MHz, V_{DS} = 15 V	1150	pF
Reverse Transfer Capacitance	C _{RSS}		495	
Total Gate Charge	Q _{G(TOT)}		40.2	
Threshold Gate Charge	Q _{G(TH)}		6.4	nC
Gate-to-Source Charge	Q _{GS}	V _{GS} = 4.5 V, V _{DS} = 15 V; I _D = 23 A	15.3	nc
Gate-to-Drain Charge	Q _{GD}		13.4	
Total Gate Charge	Q _{G(TOT)}	V_{GS} = 10 V, V_{DS} = 15 V, I _D = 23 A	83.6	nC

SWITCHING CHARACTERISTICS (Note 4)

Turn-On Delay Time	t _{d(ON)}		26	
Rise Time	t _r	V _{GS} = 4.5 V, V _{DS} = 15 V,	24	
Turn-Off Delay Time	t _{d(OFF)}	I_D = 15 A, R_G = 3.0 Ω	36	ns
Fall Time	t _f		13	

Pulse Test: pulse width ≤ 300 μs, duty cycle ≤ 2%.
Switching characteristics are independent of operating junction temperatures.

ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise specified)

Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
SWITCHING CHARACTERISTICS (No	ote 4)						
Turn-On Delay Time	t _{d(ON)}				15.7		
Rise Time	t _r	V _{GS} = 10 V, V _D	_{IS} = 15 V,		21.2		ns
Turn-Off Delay Time	t _{d(OFF)}	$I_{\rm D} = 15 \rm A, R_{\rm G}$	= 3.0 Ω		44.6		
Fall Time	t _f	1			14.5		1
DRAIN-SOURCE DIODE CHARACTE	ERISTICS						
Forward Diode Voltage	V _{SD}	$V_{GS} = 0 V, I_{S} = 2.0 A T_{J} = 25^{\circ}C T_{J} = 125^{\circ}C$		0.35	0.70	Ň	
				0.26		V	
Reverse Recovery Time	t _{RR}	·			39.1		
Charge Time	t _a	V _{GS} = 0 V, dI _S /dt	= 100 A/μs,		20.1		ns
Discharge Time	t _b	$V_{GS} = 0 \text{ V}, \text{ dI}_S/\text{dt} = 100 \text{ A}/\mu\text{s},$ $\text{I}_S = 23 \text{ A}$			19		
Reverse Recovery Charge	Q _{RR}				34		nC
PACKAGE PARASITIC VALUES							
Source Inductance	L _S	− T _A = 25°C			0.66		nH
Drain Inductance	L _D				0.20		
Gate Inductance	L _G				1.5		

0.7

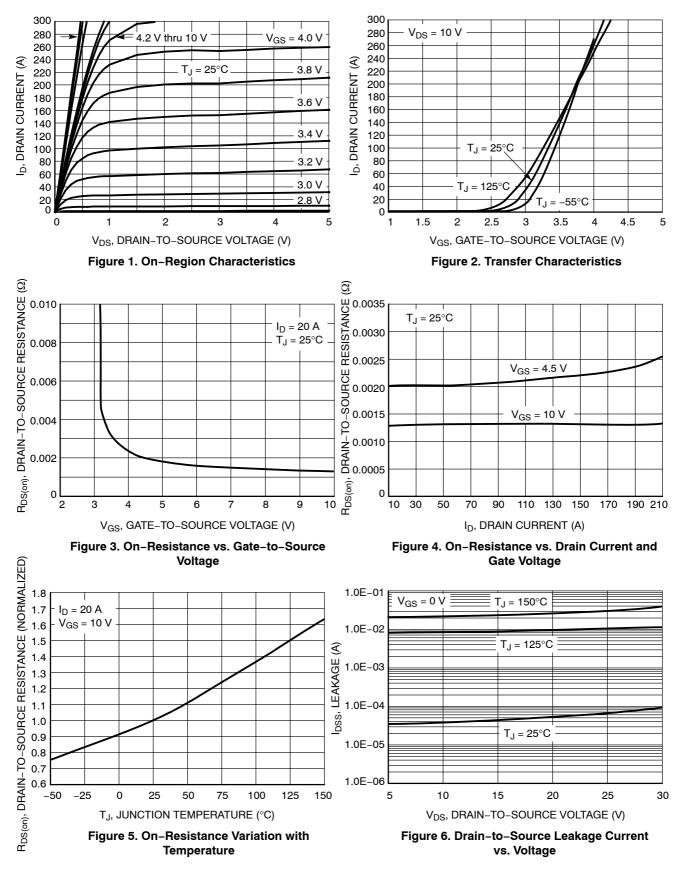
2.0

Ω

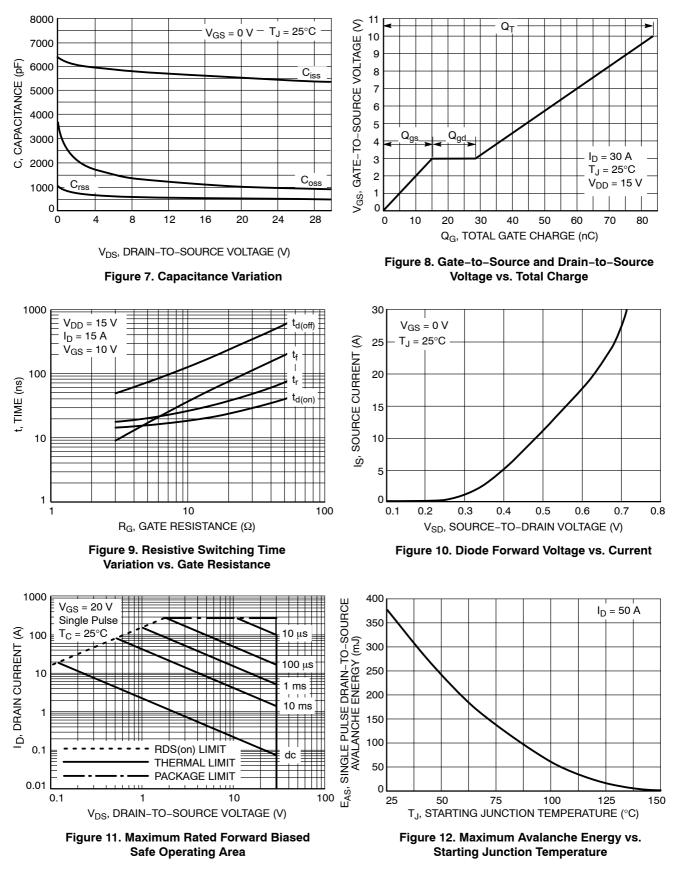
Gate Resistance

 R_G

TYPICAL PERFORMANCE CURVES



TYPICAL PERFORMANCE CURVES







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